

# FQP3N60C

## 600V N-Channel MOSFET

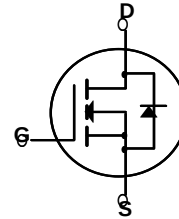
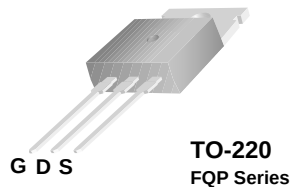
### Features

- 3A, 600V,  $R_{DS(on)} = 3.4\Omega$  @  $V_{GS} = 10V$
- Low gate charge ( typical 10.5 nC)
- Low  $C_{rss}$  ( typical 5 pF)
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability

### Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction, electronic lamp ballasts based on half bridge topology.



### Absolute Maximum Ratings

| Symbol         | Parameter                                                                                                | FQP3N60C    | Unit                     |
|----------------|----------------------------------------------------------------------------------------------------------|-------------|--------------------------|
| $V_{DSS}$      | Drain-Source Voltage                                                                                     | 600         | V                        |
| $I_D$          | Drain Current<br>- Continuous ( $T_C = 25^\circ\text{C}$ )<br>- Continuous ( $T_C = 100^\circ\text{C}$ ) | 3<br>1.8    | A<br>A                   |
| $I_{DM}$       | Drain Current - Pulsed (Note 1)                                                                          | 12          | A                        |
| $V_{GSS}$      | Gate-Source voltage                                                                                      | $\pm 30$    | V                        |
| $E_{AS}$       | Single Pulsed Avalanche Energy (Note 2)                                                                  | 150         | mJ                       |
| $I_{AR}$       | Avalanche Current (Note 1)                                                                               | 3           | A                        |
| $E_{AR}$       | Repetitive Avalanche Energy (Note 1)                                                                     | 7.5         | mJ                       |
| dv/dt          | Peak Diode Recovery dv/dt (Note 3)                                                                       | 4.5         | V/ns                     |
| $P_D$          | Power Dissipation ( $T_C = 25^\circ\text{C}$ )<br>- Derate above $25^\circ\text{C}$                      | 75<br>0.62  | W<br>W/ $^\circ\text{C}$ |
| $T_J, T_{STG}$ | Operating and Storage Temperature Range                                                                  | -55 to +150 | $^\circ\text{C}$         |
| $T_L$          | Maximum Lead Temperature for Soldering Purpose,<br>1/8" from Case for 5 Seconds                          | 300         | $^\circ\text{C}$         |

### Thermal Characteristics

| Symbol          | Parameter                               | Typ. | Max. | Unit               |
|-----------------|-----------------------------------------|------|------|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction-to-Case    | --   | 1.67 | $^\circ\text{C/W}$ |
| $R_{\theta CS}$ | Thermal Resistance, Junction-to-Case    | 0.5  | --   | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | --   | 62.5 | $^\circ\text{C/W}$ |

## Package Marking and Ordering Information

| Device Marking | Device   | Package | Reel Size | Tape Width | Quantity |
|----------------|----------|---------|-----------|------------|----------|
| FQP3N60C       | FQP3N60C | TO-220  | -         | -          | 50       |

## Electrical Characteristics T<sub>C</sub> = 25°C unless otherwise noted

| Symbol                                                 | Parameter                                             | Conditions                                                                                     | Min.     | Typ.     | Max     | Units    |
|--------------------------------------------------------|-------------------------------------------------------|------------------------------------------------------------------------------------------------|----------|----------|---------|----------|
| Off Characteristics                                    |                                                       |                                                                                                |          |          |         |          |
| BV <sub>DSS</sub>                                      | Drain-Source Breakdown Voltage                        | V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA                                                   | 600      | --       | --      | V        |
| ΔBV <sub>DSS</sub> / ΔT <sub>J</sub>                   | Breakdown Voltage Temperature Coefficient             | I <sub>D</sub> = 250μA, Referenced to 25°C                                                     | --       | 0.6      | --      | V/°C     |
| I <sub>DSS</sub>                                       | Zero Gate Voltage Drain Current                       | V <sub>DS</sub> = 600V, V <sub>GS</sub> = 0V<br>V <sub>DS</sub> = 480V, T <sub>C</sub> = 125°C | --<br>-- | --<br>-- | 1<br>10 | μA<br>μA |
| I <sub>GSSF</sub>                                      | Gate-Body Leakage Current, Forward                    | V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V                                                    | --       | --       | 100     | nA       |
| I <sub>GSSR</sub>                                      | Gate-Body Leakage Current, Reverse                    | V <sub>GS</sub> = -30V, V <sub>DS</sub> = 0V                                                   | --       | --       | -100    | nA       |
| On Characteristics                                     |                                                       |                                                                                                |          |          |         |          |
| V <sub>GS(th)</sub>                                    | Gate Threshold Voltage                                | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA                                     | 2.0      | --       | 4.0     | V        |
| R <sub>DS(on)</sub>                                    | Static Drain-Source On-Resistance                     | V <sub>GS</sub> = 10V, I <sub>D</sub> = 1.5A                                                   | --       | 2.8      | 3.4     | Ω        |
| g <sub>FS</sub>                                        | Forward Transconductance                              | V <sub>DS</sub> = 40V, I <sub>D</sub> = 1.5A (Note 4)                                          | --       | 3.5      | --      | S        |
| Dynamic Characteristics                                |                                                       |                                                                                                |          |          |         |          |
| C <sub>iss</sub>                                       | Input Capacitance                                     | V <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V,<br>f = 1.0MHz                                     | --       | 435      | 565     | pF       |
| C <sub>oss</sub>                                       | Output Capacitance                                    |                                                                                                | --       | 45       | 60      | pF       |
| C <sub>rss</sub>                                       | Reverse Transfer Capacitance                          |                                                                                                | --       | 5        | 8       | pF       |
| Switching Characteristics                              |                                                       |                                                                                                |          |          |         |          |
| t <sub>d(on)</sub>                                     | Turn-On Delay Time                                    | V <sub>DD</sub> = 300V, I <sub>D</sub> = 3A<br>R <sub>G</sub> = 25Ω<br><br>(Note 4, 5)         | --       | 12       | 34      | ns       |
| t <sub>r</sub>                                         | Turn-On Rise Time                                     |                                                                                                | --       | 30       | 70      | ns       |
| t <sub>d(off)</sub>                                    | Turn-Off Delay Time                                   |                                                                                                | --       | 35       | 80      | ns       |
| t <sub>f</sub>                                         | Turn-Off Fall Time                                    |                                                                                                | --       | 35       | 80      | ns       |
| Q <sub>g</sub>                                         | Total Gate Charge                                     | V <sub>DS</sub> = 480V, I <sub>D</sub> = 3A<br>V <sub>GS</sub> = 10V<br><br>(Note 4, 5)        | --       | 10.5     | 14      | nC       |
| Q <sub>gs</sub>                                        | Gate-Source Charge                                    |                                                                                                | --       | 2.1      | --      | nC       |
| Q <sub>gd</sub>                                        | Gate-Drain Charge                                     |                                                                                                | --       | 4.5      | --      | nC       |
| Drain-Source Diode Characteristics and Maximum Ratings |                                                       |                                                                                                |          |          |         |          |
| I <sub>S</sub>                                         | Maximum Continuous Drain-Source Diode Forward Current |                                                                                                | --       | --       | 3       | A        |
| I <sub>SM</sub>                                        | Maximum Pulsed Drain-Source Diode Forward Current     |                                                                                                | --       | --       | 12      | A        |
| V <sub>SD</sub>                                        | Drain-Source Diode Forward Voltage                    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 3A                                                      | --       | --       | 1.4     | V        |
| t <sub>rr</sub>                                        | Reverse Recovery Time                                 | V <sub>GS</sub> = 0V, I <sub>S</sub> = 3A<br>dI <sub>F</sub> /dt = 100A/μs (Note 4)            | --       | 260      | --      | ns       |
| Q <sub>rr</sub>                                        | Reverse Recovery Charge                               |                                                                                                | --       | 1.6      | --      | μC       |

### NOTES:

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I<sub>AS</sub> = 3A, V<sub>DD</sub> = 50V, L = 30mH, R<sub>G</sub> = 25Ω, Starting T<sub>J</sub> = 25°C
3. I<sub>SD</sub> ≤ 3A, di/dt ≤ 200A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25°C
4. Pulse Test: Pulse width ≤ 300μs, Duty Cycle ≤ 2%
5. Essentially Independent of Operating Temperature Typical Characteristics